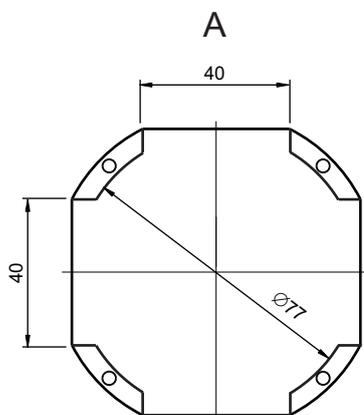
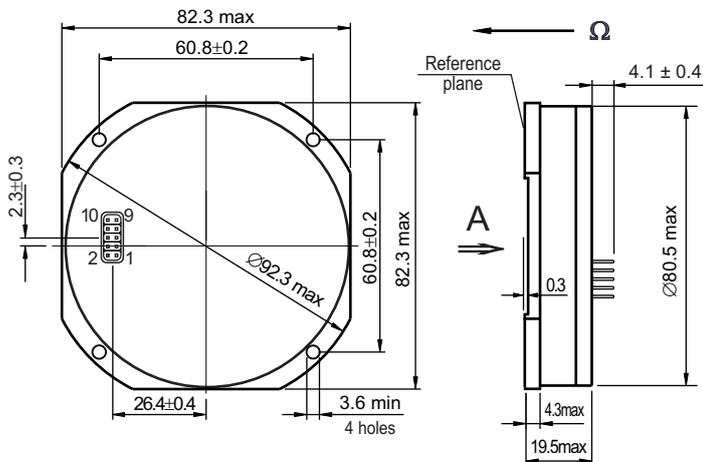
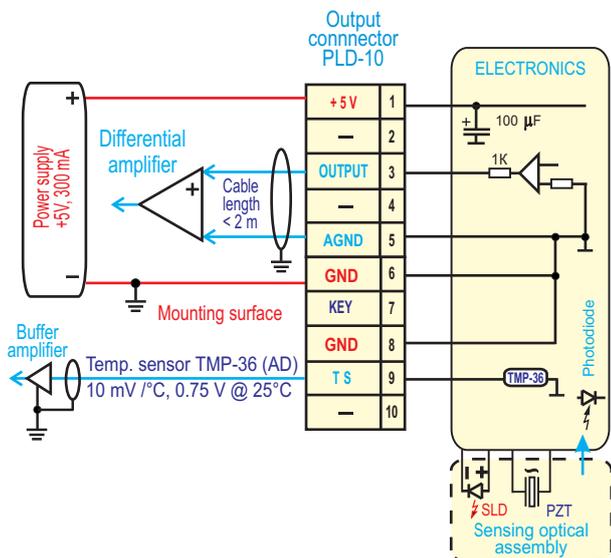


OUTLINE DRAWING



CONNECTION DIAGRAM



MAIN PARAMETERS (typical values)

- ◆ Rate range 150 deg/s
- ◆ Scale Factor (SF) 7 mV/deg/s
- ◆ Frequency range 0... 0.45 kHz
- ◆ Angle random walk 0.04 deg / \sqrt{h}
- ◆ Bias stability, RMS 2 deg / h
- ◆ SF stability, RMS 0.1 %
- ◆ Readiness time 0.1 s

ENVIRONMENT

- ◆ Temperature operating -40°C ... +70°C
- ◆ Temperature endurance -55°C... +85°C
- ◆ Vibration (operating), RMS 6 g, 20Hz... 2000Hz
- ◆ Vibration (endurance), RMS 18 g, 20Hz... 2000Hz
- ◆ Shocks (endurance) 450 g, 3 ms

RELIABILITY

- ◆ MTBF 95000 hours (20°C, predicted)
- ◆ Lifetime (predicted) 15 years
- ◆ Precision class - ④
- ◆ Estimated for low humidity

DESCRIPTION OF OUTPUT CONNECTOR PLD-10

| Contact | Name | Comments |
|---------|--------|---|
| 1 | + 5 V | Power input +5V \pm 0.25V, 200mA max, ripple 10mV max within 0-1MHz |
| 2, 4 | — | Reserved |
| 3 | OUTPUT | Output voltage proportional to rotation, scale factor 7 mV/deg/sec. Differential input recommended. |
| 5 | AGND | Analog ground to use with "OUTPUT". Differential input recommended. Galvanic coupling with "GND". |
| 6, 8 | GND | Power return line, ground, "floating" contact to housing |
| 7 | KEY | Shortened pin |
| 9 | TS | Output of temperature sensor (TMP-36) 10mv per deg.C; 0.75V at 25 deg.C |
| 10 | — | Reserved |

PHYSICAL PARAMETERS

1. Ω - sensing axis, $90^\circ \pm 0.5^\circ$ to the reference plane
2. Dissipation - 1 W
3. Weight - 150 gram (180 gram max)
4. Volume - 0.1 litre
5. Housing material - aluminum alloy
6. Housing protection - powder coating
7. Tolerances per ISO 2768-m
8. Ingress protection class - IP67

RECOMMENDATIONS AND PRECAUTIONS

1. Do not deform housing
2. Fragile components inside - no shocks, no drop
3. Treat as electrostatic sensitive unit
4. Is designed to be mounted inside water protected equipment
5. Increased humidity shortens essentially lifetime
6. Mounting surface must be grounded
7. Power must be off during connecting
8. Soldering to contacts - by low-temperature solder